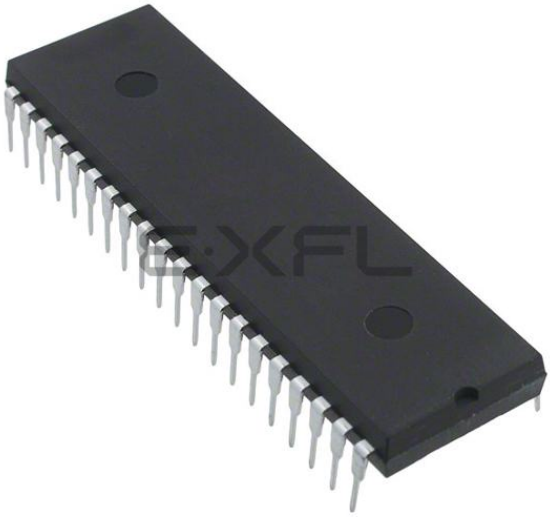

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	33
Program Memory Size	32KB (16K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18c452-e-p

NOTES:

1.0 DEVICE OVERVIEW

This document contains device specific information for the following four devices:

1. PIC18C242
2. PIC18C252
3. PIC18C442
4. PIC18C452

These devices come in 28-pin and 40-pin packages. The 28-pin devices do not have a Parallel Slave Port (PSP) implemented and the number of Analog-to-Digital (A/D) converter input channels is reduced to 5. An overview of features is shown in Table 1-1.

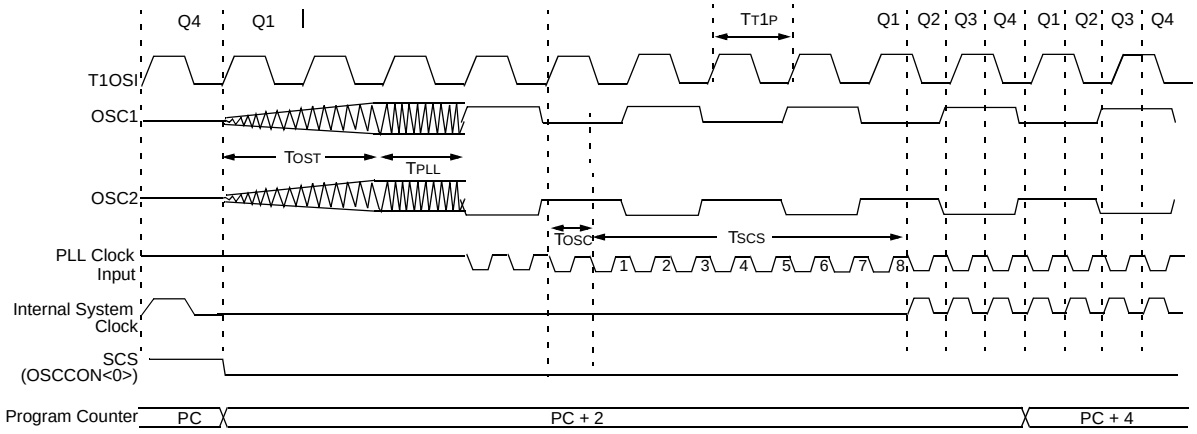
The following two figures are device block diagrams sorted by pin count: 28-pin for Figure 1-1 and 40-pin for Figure 1-2. The 28-pin and 40-pin pinouts are listed in Table 1-2 and Table 1-3, respectively.

TABLE 1-1: DEVICE FEATURES

Features	PIC18C242	PIC18C252	PIC18C442	PIC18C452
Operating Frequency	DC - 40 MHz	DC - 40 MHz	DC - 40 MHz	DC - 40 MHz
Program Memory (Bytes)	16K	32K	16K	32K
Program Memory (Instructions)	8192	16384	8192	16384
Data Memory (Bytes)	512	1536	512	1536
Interrupt Sources	16	16	17	17
I/O Ports	Ports A, B, C	Ports A, B, C	Ports A, B, C, D, E	Ports A, B, C, D, E
Timers	4	4	4	4
Capture/Compare/PWM Modules	2	2	2	2
Serial Communications	MSSP, Addressable USART	MSSP, Addressable USART	MSSP, Addressable USART	MSSP, Addressable USART
Parallel Communications	—	—	PSP	PSP
10-bit Analog-to-Digital Module	5 input channels	5 input channels	8 input channels	8 input channels
RESETS (and Delays)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)	POR, BOR, RESET Instruction, Stack Full, Stack Underflow (PWRT, OST)
Programmable Low Voltage Detect	Yes	Yes	Yes	Yes
Programmable Brown-out Reset	Yes	Yes	Yes	Yes
Instruction Set	75 Instructions	75 Instructions	75 Instructions	75 Instructions
Packages	28-pin DIP 28-pin SOIC 28-pin JW	28-pin DIP 28-pin SOIC 28-pin JW	40-pin DIP 44-pin PLCC 44-pin TQFP 40-pin JW	40-pin DIP 44-pin PLCC 44-pin TQFP 40-pin JW

If the main oscillator is configured for HS-PLL mode, an oscillator start-up time (TOST) plus an additional PLL time-out (TPLL) will occur. The PLL time-out is typically 2 ms and allows the PLL to lock to the main oscillator frequency. A timing diagram, indicating the transition from the Timer1 oscillator to the main oscillator for HS-PLL mode, is shown in Figure 2-10.

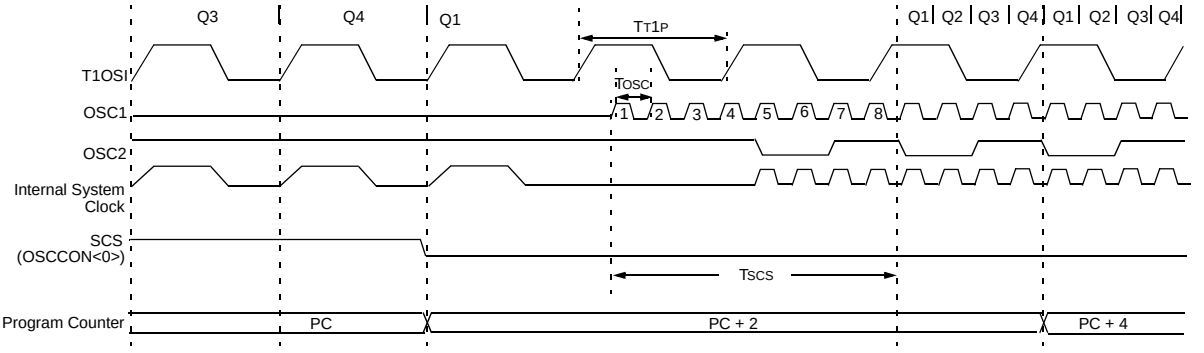
FIGURE 2-10: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (HS WITH PLL)



Note 1: TOST = 1024TOSC (drawing not to scale).

If the main oscillator is configured in the RC, RCIO, EC or ECIO modes, there is no oscillator start-up time-out. Operation will resume after eight cycles of the main oscillator have been counted. A timing diagram, indicating the transition from the Timer1 oscillator to the main oscillator for RC, RCIO, EC and ECIO modes, is shown in Figure 2-11.

FIGURE 2-11: TIMING FOR TRANSITION BETWEEN TIMER1 AND OSC1 (RC, EC)



Note 1: RC oscillator mode assumed.

TABLE 3-3: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices				Power-on Reset, Brown-out Reset	$\overline{\text{MCLR}}$ Resets WDT Reset RESET Instruction Stack Resets	Wake-up via WDT or Interrupt
ADRESH	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADRESL	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
ADCON0	242	442	252	452	0000 0000	0000 0000	uuuu uuuu
ADCON1	242	442	252	452	--0- 0000	--0- 0000	--u- uuuu
CCPR1H	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR1L	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP1CON	242	442	252	452	--00 0000	--00 0000	--uu uuuu
CCPR2H	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCPR2L	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
CCP2CON	242	442	252	452	--00 0000	--00 0000	--uu uuuu
TMR3H	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
TMR3L	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
T3CON	242	442	252	452	0000 0000	uuuu uuuu	uuuu uuuu
SPBRG	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
RCREG	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXREG	242	442	252	452	xxxx xxxx	uuuu uuuu	uuuu uuuu
TXSTA	242	442	252	452	0000 -01x	0000 -01u	uuuu -uuu
RCSTA	242	442	252	452	0000 000x	0000 000u	uuuu uuuu
IPR2	242	442	252	452	---- 1111	---- 1111	---- uuuu
PIR2	242	442	252	452	---- 0000	---- 0000	---- uuuu(1)
PIE2	242	442	252	452	---- 0000	---- 0000	---- uuuu
IPR1	242	442	252	452	1111 1111	1111 1111	uuuu uuuu
	242	442	252	452	-111 1111	-111 1111	-uuu uuuu
PIR1	242	442	252	452	0000 0000	0000 0000	uuuu uuuu(1)
	242	442	252	452	-000 0000	-000 0000	-uuu uuuu(1)
PIE1	242	442	252	452	0000 0000	0000 0000	uuuu uuuu
	242	442	252	452	-000 0000	-000 0000	-uuu uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition

Note 1: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

4: See Table 3-2 for RESET value for specific condition.

5: Bit 6 of PORTA, LATA, and TRISA are enabled in ECIO and RCIO oscillator modes only. In all other oscillator modes, they are disabled and read '0'.

6: The long write enable is only reset on a POR or $\overline{\text{MCLR}}$ Reset.

7: Bit 6 of PORTA, LATA and TRISA are not available on all devices. When unimplemented, they are read as '0'.

TABLE 4-2: REGISTER FILE SUMMARY (CONTINUED)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
WDTCON	—	—	—	—	—	—	—	SWDTE	---- ---0	183
RCON	IPEN	LWRT	—	$\overline{RI}$	$\overline{TO}$	$\overline{PD}$	$\overline{POR}$	$\overline{BOR}$	0q-1 11qq	53, 56, 74
TMR1H	Timer1 Register High Byte								xxxx xxxx	97
TMR1L	Timer1 Register Low Byte								xxxx xxxx	97
T1CON	RD16	—	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR1ON	0-00 0000	97
TMR2	Timer2 Register								0000 0000	101
PR2	Timer2 Period Register								1111 1111	102
T2CON	—	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	101
SSPBUF	SSP Receive Buffer/Transmit Register								xxxx xxxx	121
SSPADD	SSP Address Register in I^2C Slave Mode. SSP Baud Rate Reload Register in I^2C Master Mode.								0000 0000	128
SSPSTAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	0000 0000	116
SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	118
SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	0000 0000	120
ADRESH	A/D Result Register High Byte								xxxx xxxx	171,172
ADRESL	A/D Result Register Low Byte								xxxx xxxx	171,172
ADCON0	ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/$\overline{DONE}$	—	ADON	0000 00-0	165
ADCON1	ADFM	ADCS2	—	—	PCFG3	PCFG2	PCFG1	PCFG0	00-- 0000	166
CCPR1H	Capture/Compare/PWM Register1 High Byte								xxxx xxxx	111, 113
CCPR1L	Capture/Compare/PWM Register1 Low Byte								xxxx xxxx	111, 113
CCP1CON	—	—	DC1B1	DC1B0	CCP1M3	CCP1M2	CCP1M1	CCP1M0	--00 0000	107
CCPR2H	Capture/Compare/PWM Register2 High Byte								xxxx xxxx	111, 113
CCPR2L	Capture/Compare/PWM Register2 Low Byte								xxxx xxxx	111, 113
CCP2CON	—	—	DC2B1	DC2B0	CCP2M3	CCP2M2	CCP2M1	CCP2M0	--00 0000	107
TMR3H	Timer3 Register High Byte								xxxx xxxx	103
TMR3L	Timer3 Register Low Byte								xxxx xxxx	103
T3CON	RD16	T3CCP2	T3CKPS1	T3CKPS0	T3CCP1	$\overline{T3SYNC}$	TMR3CS	TMR3ON	0000 0000	103
SPBRG	USART1 Baud Rate Generator								0000 0000	151
RCREG	USART1 Receive Register								0000 0000	158, 161, 163
TXREG	USART1 Transmit Register								0000 0000	156, 159, 162
TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	149
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	150

Legend: x = unknown, u = unchanged, - = unimplemented, q = value depends on condition

Note 1: RA6 and associated bits are configured as port pins in RCIO and ECIO oscillator mode only, and read '0' in all other oscillator modes.

2: Bit 21 of the TBLPTRU allows access to the device configuration bits.

TABLE 4-2: REGISTER FILE SUMMARY (CONTINUED)

File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Details on page:
IPR2	—	—	—	—	BCLIP	LVDIP	TMR3IP	CCP2IP	---- 1111	73
PIR2	—	—	—	—	BCLIF	LVDIF	TMR3IF	CCP2IF	---- 0000	69
PIE2	—	—	—	—	BCLIE	LVDIE	TMR3IE	CCP2IE	---- 0000	71
IPR1	PSPIP	ADIP	RCIP	TXIP	SSPIP	CCP1IP	TMR2IP	TMR1IP	1111 1111	72
PIR1	PSPIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	68
PIE1	PSPIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	70
TRISE	IBF	OBF	IBOV	PSPMODE	—	Data Direction bits for PORTE			0000 -111	88
TRISD	Data Direction Control Register for PORTD								1111 1111	85
TRISC	Data Direction Control Register for PORTC								1111 1111	83
TRISB	Data Direction Control Register for PORTB								1111 1111	80
TRISA	—	TRISA6(1)	Data Direction Control Register for PORTA						-111 1111	77
LATE	—	—	—	—	—	Read PORTE Data Latch, Write PORTE Data Latch			---- -xxx	87
LATD	Read PORTD Data Latch, Write PORTD Data Latch								xxxx xxxx	85
LATC	Read PORTC Data Latch, Write PORTC Data Latch								xxxx xxxx	83
LATB	Read PORTB Data Latch, Write PORTB Data Latch								xxxx xxxx	80
LATA	—	LATA6(1)	Read PORTA Data Latch, Write PORTA Data Latch(1)						-xxx xxxx	77
PORTE	Read PORTE pins, Write PORTE Data Latch								---- -000	87
PORTD	Read PORTD pins, Write PORTD Data Latch								xxxx xxxx	85
PORTC	Read PORTC pins, Write PORTC Data Latch								xxxx xxxx	83
PORTB	Read PORTB pins, Write PORTB Data Latch								xxxx xxxx	80
PORTA	—	RA6(1)	Read PORTA pins, Write PORTA Data Latch(1)						-x0x 0000	77

Legend: x = unknown, u = unchanged, - = unimplemented, q = value depends on condition

Note 1: RA6 and associated bits are configured as port pins in RCIO and ECIO oscillator mode only, and read '0' in all other oscillator modes.

2: Bit 21 of the TBLPTRU allows access to the device configuration bits.

8.3 PORTC, TRISC and LATC Registers

PORTC is an 8-bit wide, bi-directional port. The corresponding Data Direction Register is TRISC. Setting a TRISC bit (= 1) will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISC bit (= 0) will make the corresponding PORTC pin an output (i.e., put the contents of the output latch on the selected pin).

Note:	On a Power-on Reset, these pins are configured as digital inputs.

The Data Latch register (LATC) is also memory mapped. Read-modify-write operations on the LATC register reads and writes the latched output value for PORTC.

PORTC is multiplexed with several peripheral functions (Table 8-5). PORTC pins have Schmitt Trigger input buffers.

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

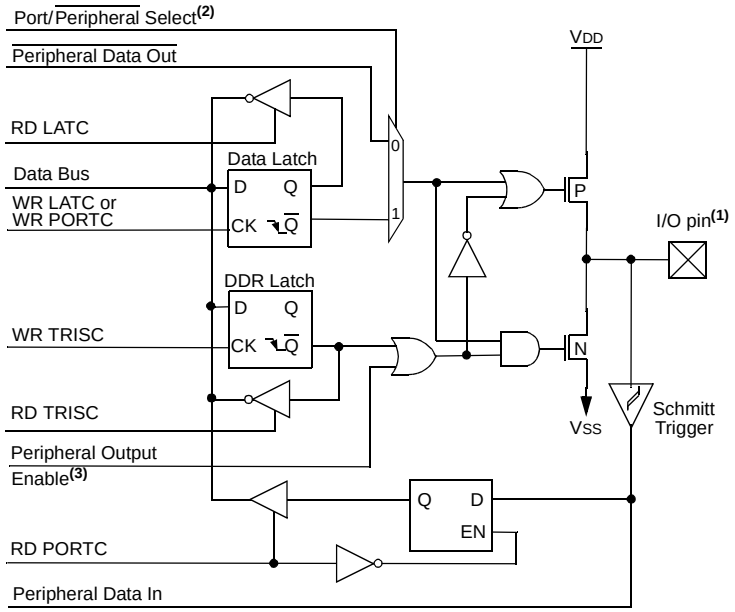
The pin override value is not loaded into the TRIS register. This allows read-modify-write of the TRIS register, without concern due to peripheral overrides.

RC1 is normally configured by the configuration bit CCP2MX as the default peripheral pin for the CCP2 module (default/erased state, CCP2MX = '1').

EXAMPLE 8-3: INITIALIZING PORTC

```
CLRF    PORTC    ; Initialize PORTC by
                 ; clearing output
                 ; data latches
CLRF    LATC     ; Alternate method
                 ; to clear output
                 ; data latches
MOVLW 0xCF       ; Value used to
                 ; initialize data
                 ; direction
MOVWF TRISC      ; Set RC<3:0> as inputs
                 ; RC<5:4> as outputs
                 ; RC<7:6> as inputs
```

FIGURE 8-7: PORTC BLOCK DIAGRAM (PERIPHERAL OUTPUT OVERRIDE)



Note 1: I/O pins have diode protection to VDD and VSS.

2: Port/Peripheral select signal selects between port data (input) and peripheral output.

3: Peripheral Output Enable is only active if peripheral select is active.

13.3 Capture Mode

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 or TMR3 registers when an event occurs on pin RC2/CCP1. An event is defined as:

- every falling edge
- every rising edge
- every 4th rising edge
- every 16th rising edge

An event is selected by control bits CCP1M3:CCP1M0 (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR1<2>) is set. It must be cleared in software. If another capture occurs before the value in register CCPR1 is read, the old captured value will be lost.

13.3.1 CCP PIN CONFIGURATION

In Capture mode, the RC2/CCP1 pin should be configured as an input by setting the TRISC<2> bit.

Note:	If the RC2/CCP1 is configured as an output, a write to the port can cause a capture condition.

13.3.2 TIMER1/TIMER3 MODE SELECTION

The timers that are to be used with the capture feature (either Timer1 and/or Timer3) must be running in Timer mode or Synchronized Counter mode. In Asynchronous Counter mode, the capture operation may not work. The timer to be used with each CCP module is selected in the T3CON register.

13.3.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep bit CCP1IE (PIE1<2>) clear to avoid false interrupts and should clear the flag bit, CCP1IF, following any such change in operating mode.

13.3.4 CCP PRESCALER

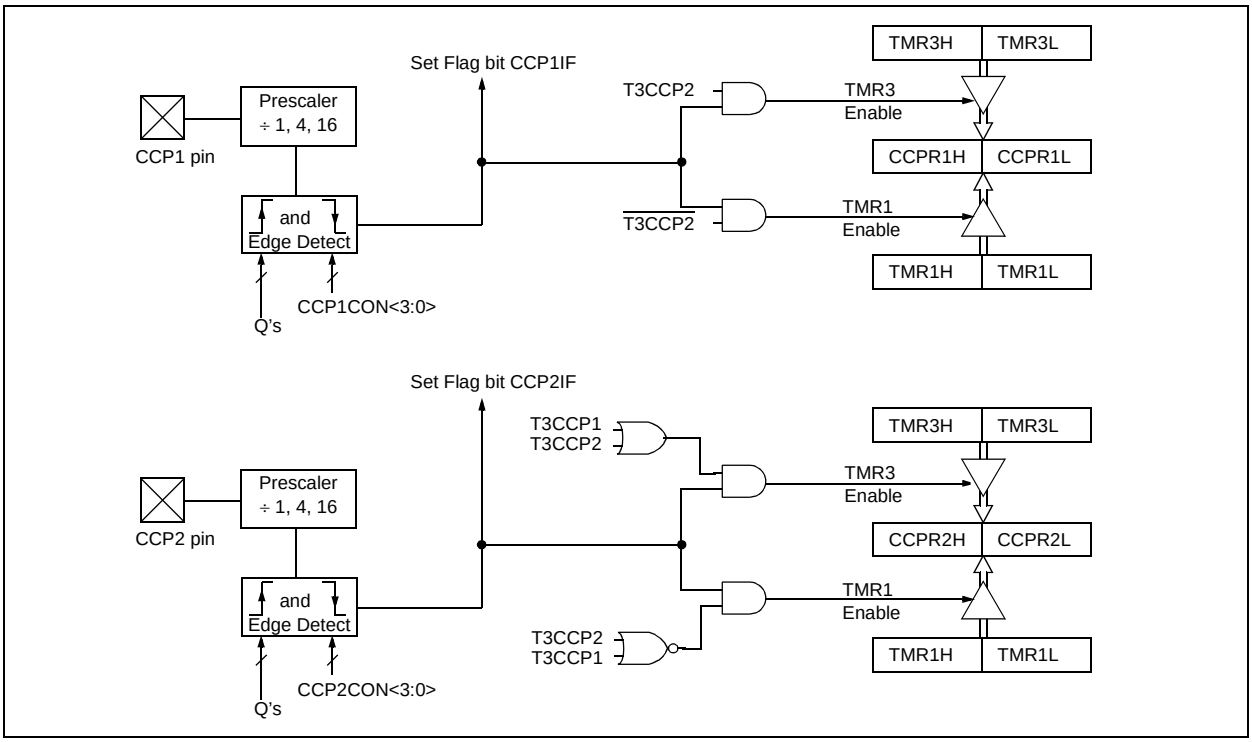
There are four prescaler settings, specified by bits CCP1M3:CCP1M0. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any RESET will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, therefore, the first capture may be from a non-zero prescaler. Example 13-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the “false” interrupt.

EXAMPLE 13-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
CLRF    CCP1CON, F ; Turn CCP module off
MOVLW  NEW_CAPT_PS ; Load WREG with the
                   ; new prescaler mode
                   ; value and CCP ON
MOVWF  CCP1CON     ; Load CCP1CON with
                   ; this value
```

FIGURE 13-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



NOTES:

14.2 Control Registers

The MSSP module has three associated registers. These include a status register (SSPSTAT) and two control registers (SSPCON1 and SSPCON2).

REGISTER 14-1: SSPSTAT: MSSP STATUS REGISTER

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF
bit 7							bit 0

bit 7 **SMP:** Sample bit

SPI Master mode:

1 = Input data sampled at end of data output time

0 = Input data sampled at middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode

In I^2C Master or Slave mode:

1 = Slew rate control disabled for standard speed mode (100 kHz and 1 MHz)

0 = Slew rate control enabled for high speed mode (400 kHz)

bit 6 **CKE:** SPI Clock Edge Select bit

CKP = 0:

1 = Data transmitted on rising edge of SCK

0 = Data transmitted on falling edge of SCK

CKP = 1:

1 = Data transmitted on falling edge of SCK

0 = Data transmitted on rising edge of SCK

bit 5 **D/$\overline{A}$:** Data/$\overline{\text{Address}}$ bit (I^2C mode only)

1 = Indicates that the last byte received or transmitted was data

0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** STOP bit

(I^2C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)

1 = Indicates that a STOP bit has been detected last (this bit is '0' on RESET)

0 = STOP bit was not detected last

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
- n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

15.0 ADDRESSABLE UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART)

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI.) The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices, such as CRT terminals and personal computers, or it can be configured as a half-duplex synchronous system that can communicate with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs, etc.

The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous - Master (half duplex)
- Synchronous - Slave (half duplex)

In order to configure pins RC6/TX/CK and RC7/RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter:

- bit SPEN (RCSTA<7>) must be set (= 1), and
- bits TRISC<7:6> must be cleared (= 0).

Register 15-1 shows the Transmit Status and Control Register (TXSTA) and Register 15-2 shows the Receive Status and Control Register (RCSTA).

REGISTER 15-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D
bit 7							bit 0

bit 7 **CSRC:** Clock Source Select bit
Asynchronous mode:
Don't care
Synchronous mode:
1 = Master mode (clock generated internally from BRG)
0 = Slave mode (clock from external source)

bit 6 **TX9**: 9-bit Transmit Enable bit
1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5 **TXEN**: Transmit Enable bit
1 = Transmit enabled
0 = Transmit disabled

Note: SREN/CREN overrides TXEN in SYNC mode.

bit 4 **SYNC**: USART Mode Select bit
1 = Synchronous mode
0 = Asynchronous mode

bit 3 **Unimplemented:** Read as '0'

bit 2 **BRGH**: High Baud Rate Select bit
Asynchronous mode:
1 = High speed
0 = Low speed
Synchronous mode:
Unused in this mode

bit 1 **TRMT**: Transmit Shift Register Status bit
1 = TSR empty
0 = TSR full

bit 0 **TX9D:** 9th bit of transmit data. Can be Address/Data bit or a parity bit.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
- n = Value at POR reset	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

The value that is in the ADRESH/ADRESL registers is not modified for a Power-on Reset. The ADRESH/ADRESL registers will contain unknown data after a Power-on Reset.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as an input. To determine acquisition time, see Section 16.1. After this acquisition time has elapsed, the A/D conversion can be started. The following steps should be followed for doing an A/D conversion:

1. Configure the A/D module:
   - Configure analog pins, voltage reference and digital I/O (ADCON1)
   - Select A/D input channel (ADCON0)
   - Select A/D conversion clock (ADCON0)
   - Turn on A/D module (ADCON0)
2. Configure A/D interrupt (if desired):
   - Clear ADIF bit
   - Set ADIE bit
   - Set GIE bit
3. Wait the required acquisition time.
4. Start conversion:
   - Set GO/$\overline{\text{DONE}}$ bit (ADCON0)
5. Wait for A/D conversion to complete, by either:
   - Polling for the GO/$\overline{\text{DONE}}$ bit to be cleared

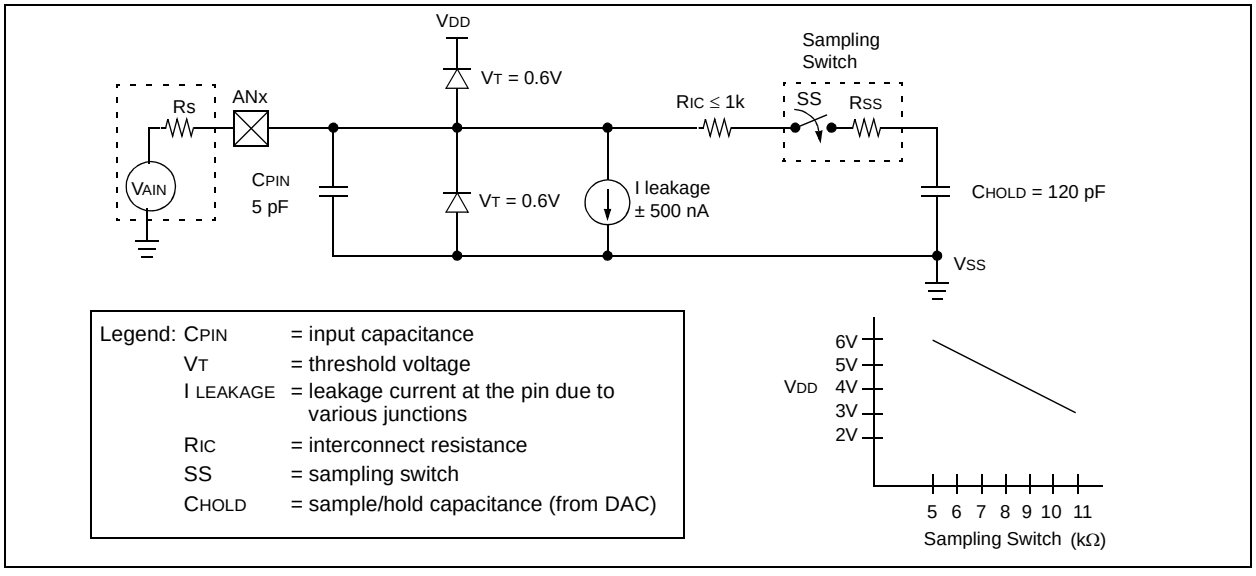
   OR
   - Waiting for the A/D interrupt
6. Read A/D Result registers (ADRESH/ADRESL); clear bit ADIF if required.
7. For next conversion, go to step 1 or step 2, as required. The A/D conversion time per bit is defined as TAD. A minimum wait of 2TAD is required before next acquisition starts.

16.1 A/D Acquisition Requirements

For the A/D converter to meet its specified accuracy, the charge holding capacitor (CHOLD) must be allowed to fully charge to the input channel voltage level. The analog input model is shown in Figure 16-2. The source impedance (RS) and the internal sampling switch (RSS) impedance directly affect the time required to charge the capacitor CHOLD. The sampling switch (RSS) impedance varies over the device voltage (VDD). The source impedance affects the offset voltage at the analog input (due to pin leakage current). **The maximum recommended impedance for analog sources is 2.5 kΩ.** After the analog input channel is selected (changed), this acquisition must be done before the conversion can be started.

Note:	When the conversion is started, the holding capacitor is disconnected from the input pin.

FIGURE 16-2: ANALOG INPUT MODEL



17.2.1 REFERENCE VOLTAGE SET POINT

The Internal Reference Voltage of the LVD module may be used by other internal circuitry (the Programmable Brown-out Reset). If these circuits are disabled (lower current consumption), the reference voltage circuit requires a time to become stable before a low voltage condition can be reliably detected. This time is invariant of system clock speed. This start-up time is specified in electrical specification parameter #36. The low voltage interrupt flag will not be enabled until a stable reference voltage is reached. Refer to the waveform in Figure 17-4.

17.2.2 CURRENT CONSUMPTION

When the module is enabled, the LVD comparator and voltage divider are enabled and will consume static current. The voltage divider can be tapped from multiple places in the resistor array. Total current consumption, when enabled, is specified in electrical specification parameter #D022B.

17.3 Operation During SLEEP

When enabled, the LVD circuitry continues to operate during SLEEP. If the device voltage crosses the trip point, the LVDIF bit will be set and the device will wake-up from SLEEP. Device execution will continue from the interrupt vector address, if interrupts have been globally enabled.

17.4 Effects of a RESET

A device RESET forces all registers to their RESET state. This forces the LVD module to be turned off.

BRA **Unconditional Branch**

Syntax: [*label*] BRA n

Operands: $-1024 \le n \le 1023$

Operation: $(PC) + 2 + 2n \rightarrow PC$

Status Affected: None

Encoding:

1101	0nnn	nnnn	nnnn

Description: Add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC+2+2n. This instruction is a two-cycle instruction.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example: `HERE BRA Jump`

Before Instruction

`PC = address (HERE)`

After Instruction

`PC = address (Jump)`

BSF **Bit Set f**

Syntax: [*label*] BSF f,b[,a]

Operands: $0 \le f \le 255$
$0 \le b \le 7$
$a \in [0,1]$

Operation: $1 \rightarrow f<b>$

Status Affected: None

Encoding:

1000	bbba	ffff	ffff

Description: Bit 'b' in register 'f' is set. If 'a' is 0 Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BSF FLAG_REG, 7, 1`

Before Instruction

`FLAG_REG= 0x0A`

After Instruction

`FLAG_REG= 0x8A`

LFSR **Load FSR**

Syntax: [*label*] LFSR f,k

Operands: $0 \le f \le 2$
$0 \le k \le 4095$

Operation: $k \rightarrow FSRf$

Status Affected: None

Encoding:

1110 1111	1110 0000	00ff $k_7$kkk	k_{11}kkk kkkk

Description: The 12-bit literal 'k' is loaded into the file select register pointed to by 'f'.

Words: 2

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k' MSB	Process Data	Write literal 'k' MSB to FSRfH
Decode	Read literal 'k' LSB	Process Data	Write literal 'k' to FSRfL

Example: `LFSR 2, 0x3AB`

After Instruction

```
FSR2H   =   0x03
FSR2L   =   0xAB
```

MOVF **Move f**

Syntax: [*label*] MOVF f [,d [,a]

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: $f \rightarrow dest$

Status Affected: N,Z

Encoding:

0101	00da	ffff	ffff

Description: The contents of register 'f' are moved to a destination dependent upon the status of ’d’. If 'd' is 0, the result is placed in WREG. If 'd' is 1, the result is placed back in register 'f' (default). Location 'f' can be anywhere in the 256 byte bank. If ’a’ is 0, the Access Bank will be selected, overriding the BSR value. If ‘a’ = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write WREG

Example: `MOVF REG, 0, 0`

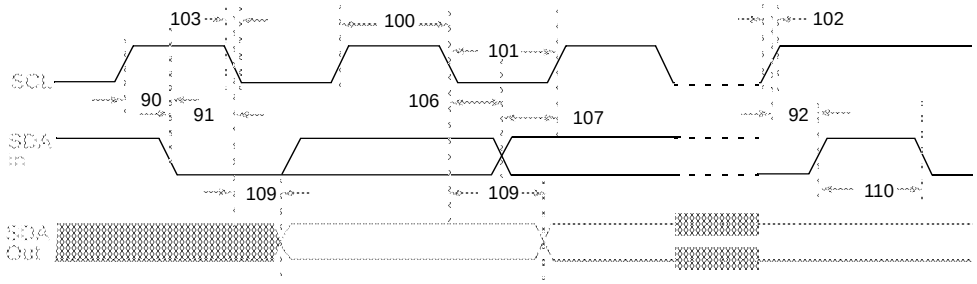
Before Instruction

```
REG     =   0x22
WREG    =   0xFF
```

After Instruction

```
REG     =   0x22
WREG    =   0x22
```

FIGURE 21-19: MASTER SSP I²C BUS DATA TIMING



Note: Refer to Figure 21-4 for load conditions.

TABLE 21-18: MASTER SSP I²C BUS DATA REQUIREMENTS

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
100	THIGH	Clock high time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
101	TLOW	Clock low time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
102	TR	SDA and SCL rise time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1CB	300	ns	
			1 MHz mode(1)	—	300	ns	
103	TF	SDA and SCL fall time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1CB	300	ns	
			1 MHz mode(1)	—	100	ns	
90	TSU:STA	START condition setup time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	Only relevant for Repeated START condition
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
91	THD:STA	START condition hold time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	After this period the first clock pulse is generated
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
106	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	ms	
			1 MHz mode(1)	TBD	—	ns	
107	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	**(Note 2)**
			400 kHz mode	100	—	ns	
			1 MHz mode(1)	TBD	—	ns	
92	TSU:STO	STOP condition setup time	100 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			400 kHz mode	2(TOSC)(BRG + 1)	—	ms	
			1 MHz mode(1)	2(TOSC)(BRG + 1)	—	ms	
109	TAA	Output valid from clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode(1)	—	—	ns	
110	TBUF	Bus free time	100 kHz mode	4.7	—	ms	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	ms	
			1 MHz mode(1)	TBD	—	ms	
D102	CB	Bus capacitive loading		—	400	pF	

Note 1: Maximum pin capacitance = 10 pF for all I²C pins.

2: A fast mode I²C bus device can be used in a standard mode I²C bus system, but parameter #107 ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line, parameter #102 + parameter #107 = 1000 + 250 = 1250 ns (for 100 kHz mode) before the SCL line is released.

TABLE 21-21: A/D CONVERTER CHARACTERISTICS: PIC18CXX2 (INDUSTRIAL, EXTENDED) PIC18LCXX2 (INDUSTRIAL)

Param No.	Symbol	Characteristic		Min	Typ	Max	Units	Conditions
A01	NR	Resolution		—	—	10	bit	VREF = VDD ≥ 3.0V
				—	—	10	bit	VREF = VDD < 3.0V
A03	EIL	Integral linearity error		—	—	<±1	LSb	VREF = VDD ≥ 3.0V
				—	—	<±2	LSb	VREF = VDD < 3.0V
A04	EDL	Differential linearity error		—	—	<±1	LSb	VREF = VDD ≥ 3.0V
				—	—	<±2	LSb	VREF = VDD < 3.0V
A05	EFS	Full scale error		—	—	<±1	LSb	VREF = VDD ≥ 3.0V
				—	—	<±1	LSb	VREF = VDD < 3.0V
A06	EOFF	Offset error		—	—	<±1	LSb	VREF = VDD ≥ 3.0V
				—	—	<±1	LSb	VREF = VDD < 3.0V
A10	—	Monotonicity		guaranteed(3)			—	VSS ≤ VAIN ≤ VREF
A20	VREF	Reference voltage (VREFH - VREFL)		0V	—	—	V	
A20A				3V	—	—	V	For 10-bit resolution
A21	VREFH	Reference voltage High		AVSS	—	AVDD + 0.3V	V	
A22	VREFL	Reference voltage Low		AVSS - 0.3V	—	AVDD	V	
A25	VAIN	Analog input voltage		AVSS - 0.3V	—	VREF + 0.3V	V	
A30	ZAIN	Recommended impedance of analog voltage source		—	—	10.0	kΩ	
A40	IAD	A/D conversion current (VDD)	PIC18**C**XXX	—	180	—	μA	Average current consumption when A/D is on **(Note 1)**.
			PIC18**LC**XXX	—	90	—	μA	
A50	IREF	VREF input current **(Note 2)**		10	—	1000	μA	During VAIN acquisition. Based on differential of VHOLD to VAIN. To charge CHOLD, see Section 16.0.
				—	—	10	μA	During A/D conversion cycle.

Note 1: When A/D is off, it will not consume any current other than minor leakage current. The power-down current spec includes any such leakage from the A/D module.
VREF current is from RA2/AN2/VREF- and RA3/AN3/VREF+ pins or AVDD and AVSS pins, whichever is selected as reference input.

2: VSS ≤ VAIN ≤ VREF

3: The A/D conversion result never decreases with an increase in the Input Voltage, and has no missing codes.

FIGURE 22-7: TYPICAL IDD vs. FOSC OVER VDD (LP MODE)

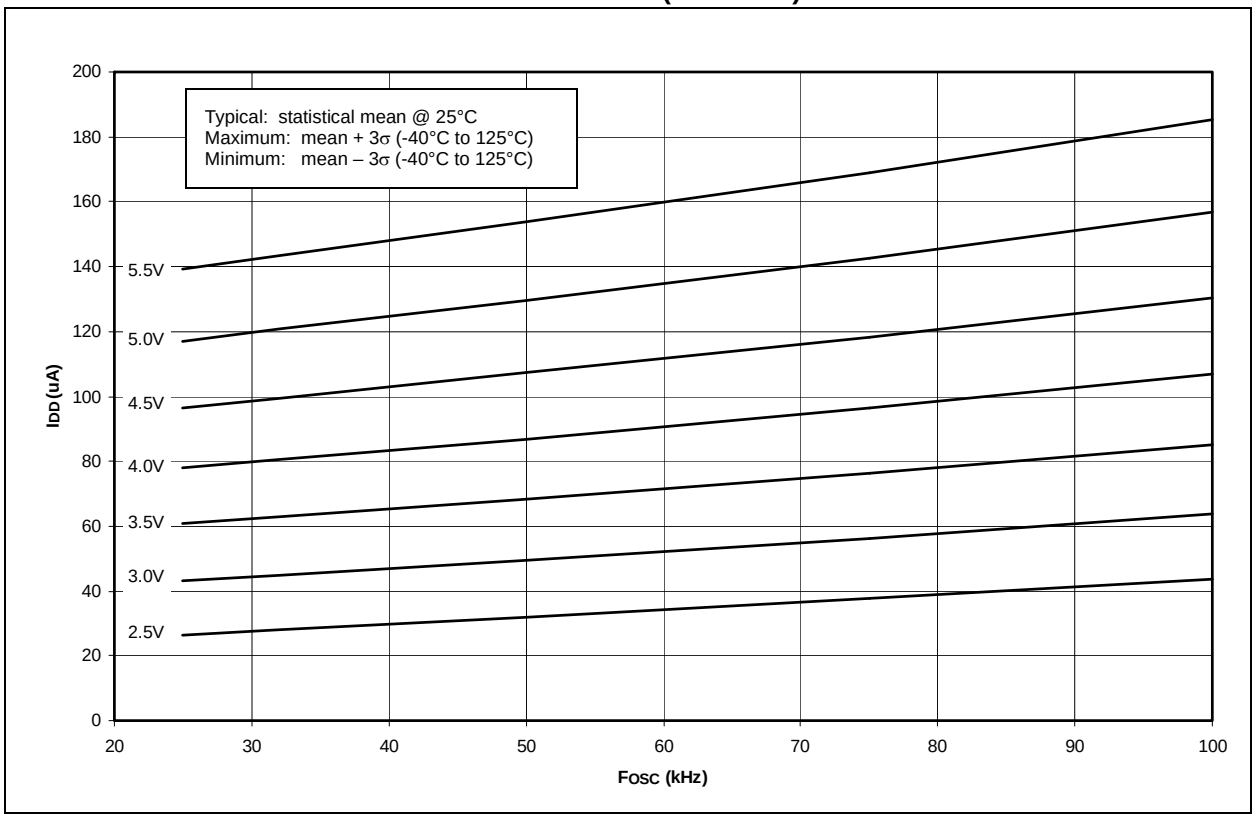
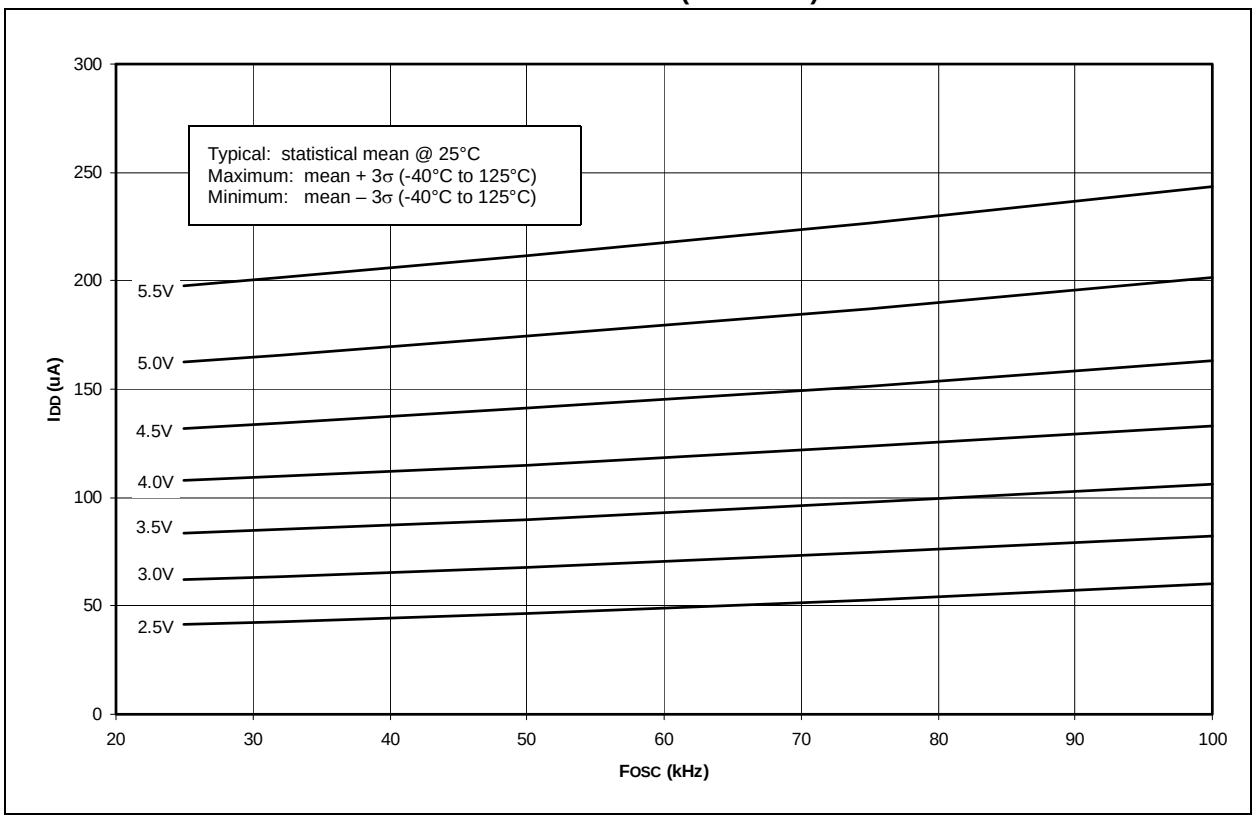


FIGURE 22-8: MAXIMUM IDD vs. FOSC OVER VDD (LP MODE)



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